

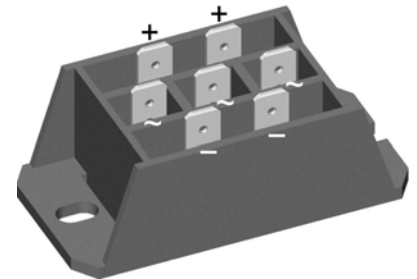
# Standard Rectifier Module

| 3~<br>Rectifier |          |
|-----------------|----------|
| $V_{RRM}$       | = 1600 V |
| $I_{DAV}$       | = 75 A   |
| $I_{FSM}$       | = 700 A  |

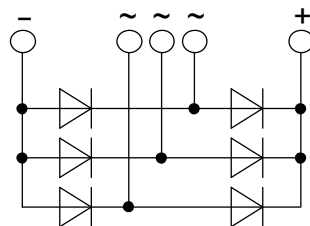
## 3~ Rectifier Bridge

Part number

**VUO60-16NO3**



 E72873



### Features / Advantages:

- Package with DCB ceramic
- Reduced weight
- Improved temperature and power cycling
- Planar passivated chips
- Very low forward voltage drop
- Very low leakage current

### Applications:

- Diode for main rectification
- For three phase bridge configurations
- Supplies for DC power equipment
- Input rectifiers for PWM inverter
- Battery DC power supplies
- Field supply for DC motors

### Package: FO-F-B

- Isolation Voltage: 3600 V~
- Industry standard outline
- RoHS compliant
- 1/4" fast-on terminals
- Easy to mount with two screws
- Base plate: DCB ceramic
- Reduced weight
- Advanced power cycling

| Rectifier  |                                              |                                         |                                | Ratings                        |      |      |                   |
|------------|----------------------------------------------|-----------------------------------------|--------------------------------|--------------------------------|------|------|-------------------|
| Symbol     | Definition                                   | Conditions                              |                                | min.                           | typ. | max. | Unit              |
| $V_{RSM}$  | max. non-repetitive reverse blocking voltage | $T_{VJ} = 25^{\circ}\text{C}$           |                                |                                |      | 1700 | V                 |
| $V_{RRM}$  | max. repetitive reverse blocking voltage     | $T_{VJ} = 25^{\circ}\text{C}$           |                                |                                |      | 1600 | V                 |
| $I_R$      | reverse current                              | $V_R = 1600\text{ V}$                   | $T_{VJ} = 25^{\circ}\text{C}$  |                                |      | 100  | $\mu\text{A}$     |
|            |                                              | $V_R = 1600\text{ V}$                   | $T_{VJ} = 150^{\circ}\text{C}$ |                                |      | 1.5  | mA                |
| $V_F$      | forward voltage drop                         | $I_F = 25\text{ A}$                     | $T_{VJ} = 25^{\circ}\text{C}$  |                                |      | 1.06 | V                 |
|            |                                              | $I_F = 75\text{ A}$                     |                                |                                |      | 1.30 | V                 |
|            |                                              | $I_F = 25\text{ A}$                     | $T_{VJ} = 125^{\circ}\text{C}$ |                                |      | 0.96 | V                 |
|            |                                              | $I_F = 75\text{ A}$                     |                                |                                |      | 1.27 | V                 |
| $I_{DAV}$  | bridge output current                        | $T_C = 110^{\circ}\text{C}$             | $T_{VJ} = 150^{\circ}\text{C}$ |                                |      | 75   | A                 |
|            |                                              | rectangular $d = \frac{1}{3}$           |                                |                                |      |      |                   |
| $V_{FO}$   | threshold voltage                            | } for power loss calculation only       |                                | $T_{VJ} = 150^{\circ}\text{C}$ |      | 0.77 | V                 |
| $r_F$      | slope resistance                             |                                         |                                |                                |      | 6.5  | m $\Omega$        |
| $R_{thJC}$ | thermal resistance junction to case          |                                         |                                |                                |      | 1.2  | K/W               |
| $R_{thCH}$ | thermal resistance case to heatsink          |                                         |                                |                                | 0.4  |      | K/W               |
| $P_{tot}$  | total power dissipation                      | $T_C = 25^{\circ}\text{C}$              |                                |                                |      | 100  | W                 |
| $I_{FSM}$  | max. forward surge current                   | $t = 10\text{ ms; (50 Hz), sine}$       | $T_{VJ} = 45^{\circ}\text{C}$  |                                |      | 700  | A                 |
|            |                                              | $t = 8,3\text{ ms; (60 Hz), sine}$      | $V_R = 0\text{ V}$             |                                |      | 755  | A                 |
|            |                                              | $t = 10\text{ ms; (50 Hz), sine}$       | $T_{VJ} = 150^{\circ}\text{C}$ |                                |      | 595  | A                 |
|            |                                              | $t = 8,3\text{ ms; (60 Hz), sine}$      | $V_R = 0\text{ V}$             |                                |      | 645  | A                 |
| $I^2t$     | value for fusing                             | $t = 10\text{ ms; (50 Hz), sine}$       | $T_{VJ} = 45^{\circ}\text{C}$  |                                |      | 2.45 | kA <sup>2</sup> s |
|            |                                              | $t = 8,3\text{ ms; (60 Hz), sine}$      | $V_R = 0\text{ V}$             |                                |      | 2.37 | kA <sup>2</sup> s |
|            |                                              | $t = 10\text{ ms; (50 Hz), sine}$       | $T_{VJ} = 150^{\circ}\text{C}$ |                                |      | 1.77 | kA <sup>2</sup> s |
|            |                                              | $t = 8,3\text{ ms; (60 Hz), sine}$      | $V_R = 0\text{ V}$             |                                |      | 1.73 | kA <sup>2</sup> s |
| $C_J$      | junction capacitance                         | $V_R = 400\text{ V; } f = 1\text{ MHz}$ |                                | $T_{VJ} = 25^{\circ}\text{C}$  |      | 25   | pF                |

| Package FO-F-B       |                                                              |                      |                                         | Ratings |      |      |      |
|----------------------|--------------------------------------------------------------|----------------------|-----------------------------------------|---------|------|------|------|
| Symbol               | Definition                                                   | Conditions           |                                         | min.    | typ. | max. | Unit |
| I <sub>RMS</sub>     | RMS current                                                  | per terminal         |                                         |         |      | 100  | A    |
| T <sub>stg</sub>     | storage temperature                                          |                      |                                         | -40     |      | 125  | °C   |
| T <sub>VJ</sub>      | virtual junction temperature                                 |                      |                                         | -40     |      | 150  | °C   |
| Weight               |                                                              |                      |                                         |         | 45   |      | g    |
| M <sub>D</sub>       | mounting torque                                              |                      |                                         | 2       |      | 2.5  | Nm   |
| d <sub>Spp/App</sub> | creepage distance on surface   striking distance through air | terminal to terminal | 18.0                                    | 6.0     |      |      | mm   |
| d <sub>Spb/Apb</sub> |                                                              | terminal to backside | 26.0                                    | 20.0    |      |      | mm   |
| V <sub>ISOL</sub>    | isolation voltage                                            | t = 1 second         | 50/60 Hz, RMS; I <sub>ISOL</sub> ≤ 1 mA | 3600    |      |      | V    |
|                      |                                                              | t = 1 minute         |                                         | 3000    |      |      | V    |

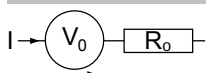


| Ordering | Part Number | Marking on Product | Delivery Mode | Quantity | Code No. |
|----------|-------------|--------------------|---------------|----------|----------|
| Standard | VUO60-16NO3 | VUO60-16NO3        | Box           | 10       | 465348   |

## Equivalent Circuits for Simulation

\* on die level

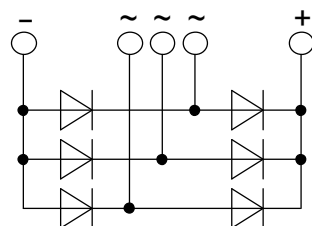
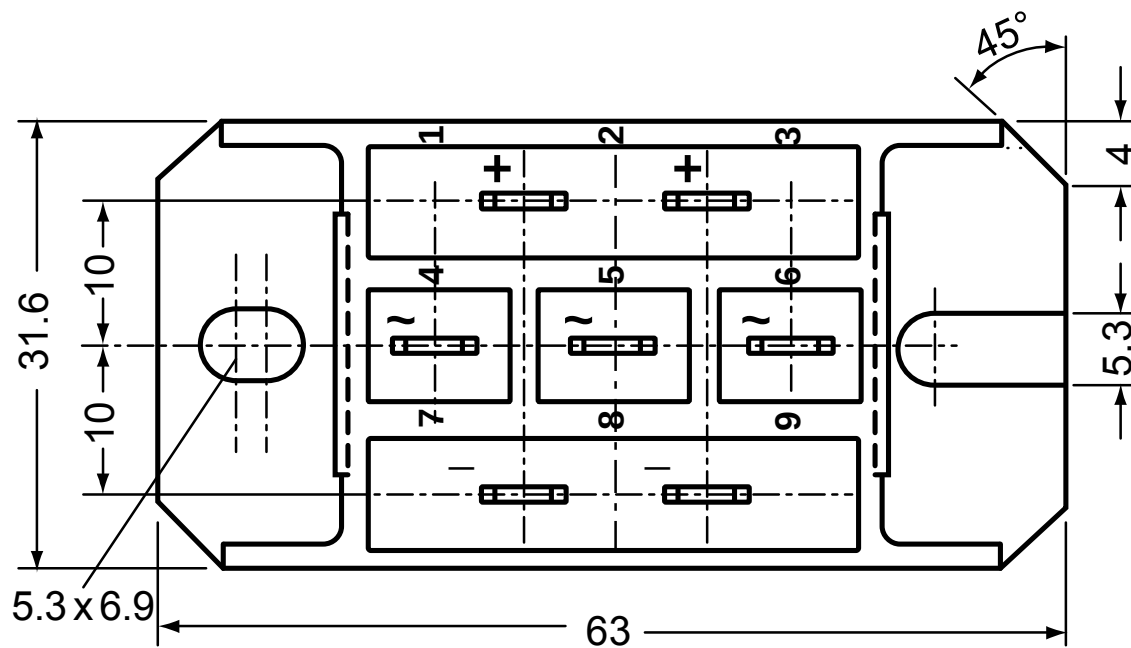
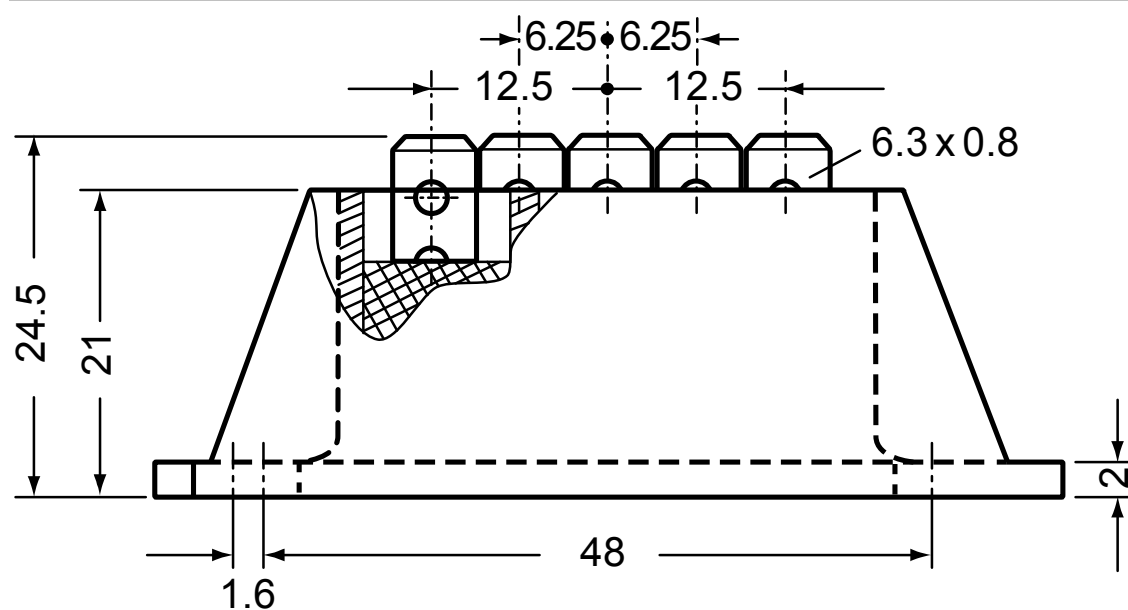
$T_{VJ} = 150^\circ\text{C}$



Rectifier

|             |                    |      |    |
|-------------|--------------------|------|----|
| $V_{0\max}$ | threshold voltage  | 0.77 | V  |
| $R_{0\max}$ | slope resistance * | 5.3  | mΩ |

Outlines FO-F-B



## Rectifier

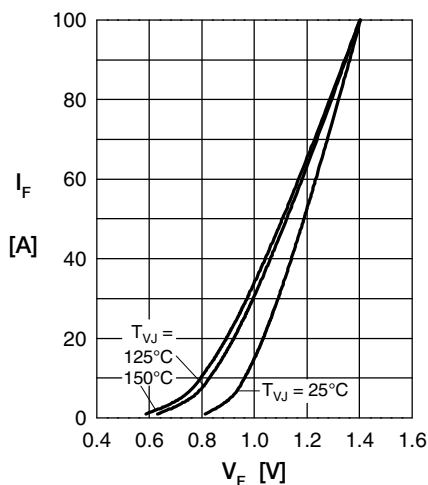


Fig. 1 Forward current vs. voltage drop per diode

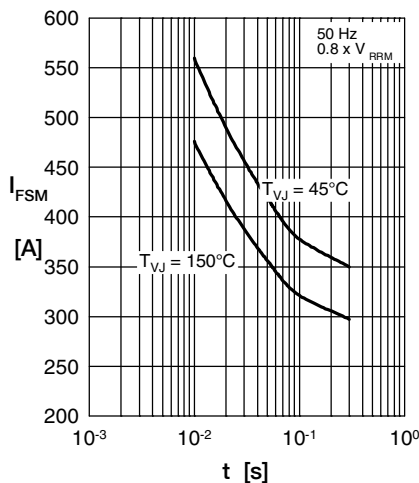


Fig. 2 Surge overload current vs. time per diode

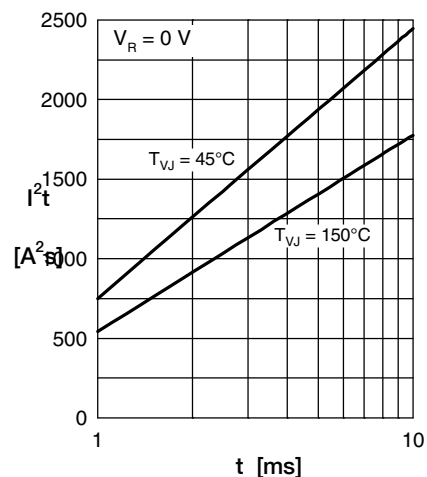


Fig. 3  $I^2t$  vs. time per diode

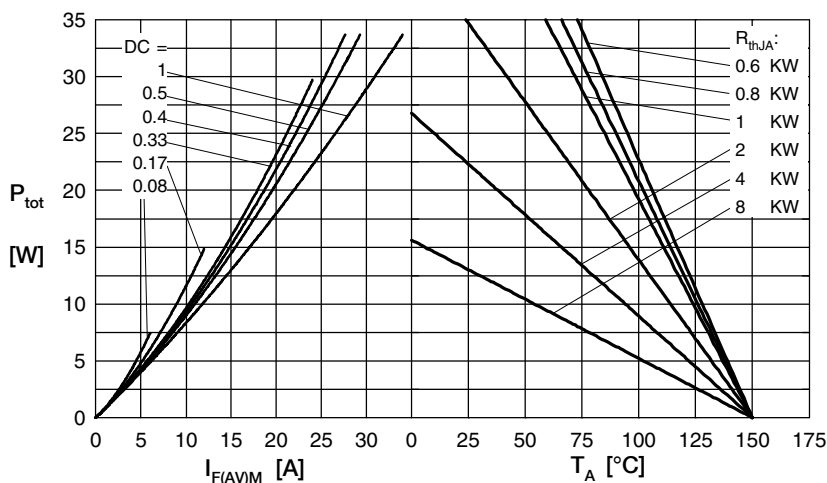


Fig. 4 Power dissipation vs. forward current and ambient temperature per diode

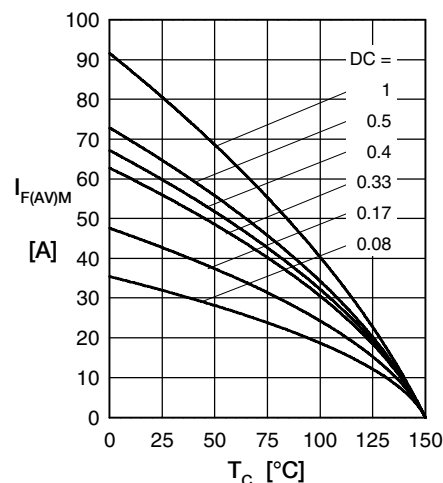


Fig. 5 Max. forward current vs. case temperature per diode

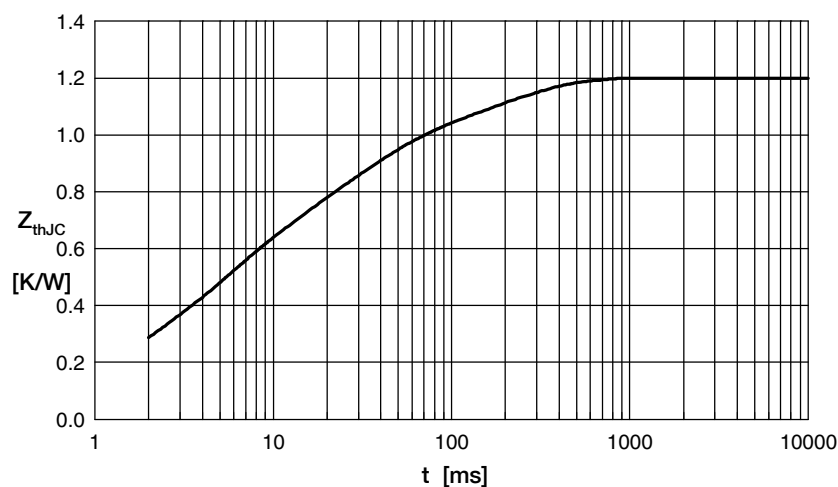


Fig. 6 Transient thermal impedance junction to case vs. time per diode

Constants for  $Z_{thJC}$  calculation:

| i | $R_{th}$ (K/W) | $t_i$ (s) |
|---|----------------|-----------|
| 1 | 0.0607         | 0.00040   |
| 2 | 0.1330         | 0.00256   |
| 3 | 0.3305         | 0.00450   |
| 4 | 0.4130         | 0.02420   |
| 5 | 0.2628         | 0.18000   |